



## ***SPEAKERS INVITED TO PRESENT AT THE 2008 INTERNATIONAL CONFERENCE ON NANOTECHNOLOGY FOR THE FOREST PRODUCTS INDUSTRY***

TAPPI is seeking presenters for the 2008 International Conference on Nanotechnology for the Forest Products Industry. The conference will be presented by TAPPI and co-sponsored by The Forest Products Society (FPS), June 25-27, 2008, at the Hyatt Regency St. Louis in St. Louis, Missouri, USA.

This comprehensive conference is the third annual TAPPI/FPS international conference focused on state-of-the-art research, development, and deployment of nanotechnology science and technology for the global forest products community. Working on the theme "Nanotechnology from Research and Development to Application", the 2008 International Conference will consider all science- and technology-focused presentations on the following topics:

- nanotechnology product applications and industry perspectives
- forest materials-based nano-manufacturing
- nanotechnology in papermaking
- nanotechnology in paper coating
- nanotechnology in printing
- nanocomposites
- nanotechnology in biorefining and lignin biodegradation
- reinforced and interfacial structures
- self-assembly / biomimicry
- nanobiotechnology and wood quality
- nanocrystalline cellulose and nanodimensional cell wall structures
- characterization, measurement, and modification of nanoscale surfaces, structures, and properties
- novel photonic, piezoelectric, thermal and mechanical properties and interactions
- nanosensors
- environment, health, and safety
- international and national nanotechnology programs and funding
- future directions including industry priorities, opportunities, and more.

Authors interested in presenting at the conference should submit an [abstract or technical paper](#) online before January 11, 2008. For general information, see [www.tappi.org/08nano](http://www.tappi.org/08nano) or for further technical information, contact Karen Murray, technical program coordinator, at [kmurray@tappi.org](mailto:kmurray@tappi.org) 770-209-7221.